

BYD33DGP thru BYD33MGP

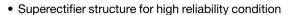
Vishay General Semiconductor

Avalanche Glass Passivated Junction Fast Switching Rectifier



PRIMARY CHARACTERISTICS						
I _{F(AV)}	1.0 A					
V _{RRM}	200 V to 1000 V					
I _{FSM}	30 A					
E _{RSM}	10 mJ, 7 mJ					
t _{rr}	150 ns, 250 ns, 300 ns					
I _R	5.0 μΑ					
T _J max.	175 °C					

FEATURES





- · Cavity-free glass-passivated junction
- · Avalanche surge capability guaranteed
- Fast reverse recovery time
- · Low switching losses, high efficiency
- Low leakage current, typical I_R less than 0.1 μA
- · High forward surge capability
- Meets environmental standard MIL-S-19500
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in high frequency rectification of switching power supplies, inverters, converters and freewheeling applications for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-204AL, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test. HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	BYD33DGP	BYD33GGP	BYD33JGP	BYD33KGP	BYD33MGP	UNIT
Device marking code		33DGP	33GGP	33JGP	33KGP	33MGP	V
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Maximum DC blocking voltage	V_{DC}	200	400	600	800	1000	V
Maximum average forward rectified current 0.375 " (9.5 mm) lead length at T_A = 55 °C	I _{F(AV)}	1.0					Α
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30					Α
Non-repetitive peak reverse avalanche energy at L = 120 mH, $T_J = T_J$ max. prior to surge	E _{RSM}	10 7				mJ	
Maximum full load reverse current, full cycle average 0.375" (9.5 mm) lead length $T_A = 55$ °C	I _{R(AV)}	100					μΑ
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175					°C

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)									
PARAMETER	TEST CONDITIONS		SYMBOL	BYD33DGP	BYD33GGP	BYD33JGP	BYD33KGP	BYD33MGP	UNIT
Maximum instantaneous forward voltage	1.0 A		V _F ⁽¹⁾	1.3					٧
Maximum DC reverse current at rated DC		T _A = 25 °C	I_	5.0					μΑ
blocking voltage		T _A = 150 °C	I _R	200					
Maximum reverse recovery time	$I_F = 0.5$ $I_{rr} = 0.2$	A, I _R = 1.0 A, 5 A	t _{rr}	150 250 300			00	ns	
Typical junction capacitance	4.0 V, 1	MHz	CJ	15			pF		

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	BYD33DGP	BYD33GGP	BYD33JGP	BYD33KGP	BYD33MGP	UNIT
Typical thermal resistance	R _{0JA} (1)	(1) 55				°C/W	

Note

⁽¹⁾ Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, PCB mounted

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
BYD33JGP-E3/54	0.336	54	5500	13" diameter paper tape and reel				
BYD33JGP-E3/73	0.336	73	3000	Ammo pack packaging				
BYD33JGPHE3/54 (1)	0.336	54	5500	13" diameter paper tape and reel				
BYD33JGPHE3/73 (1)	0.336	73	3000	Ammo pack packaging				

Note

RATINGS AND CHARACTERISTICS CURVES

 $(T_A = 25 \, ^{\circ}C \text{ unless otherwise noted})$

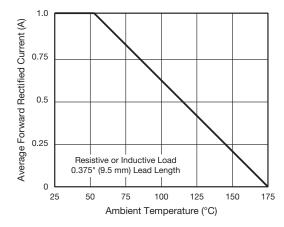


Fig. 1 - Forward Current Derating Curve

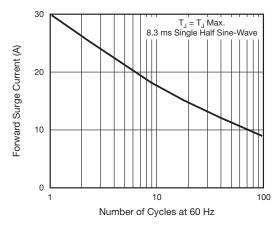


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified



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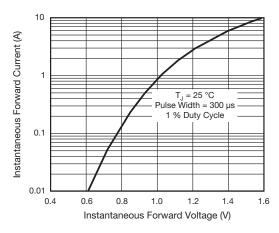


Fig. 3 - Typical Instantaneous Forward Characteristics

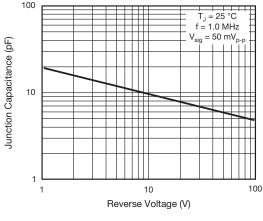


Fig. 5 - Typical Junction Capacitance

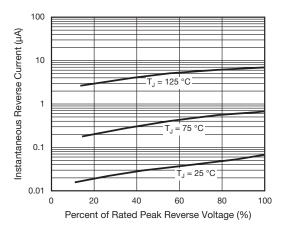


Fig. 4 - Typical Reverse Characteristics

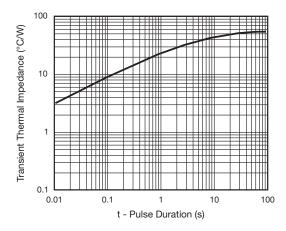
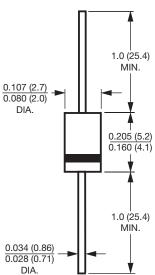


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-204AL (DO-41)



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For technical questions within your region, please contact one of the following: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com





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